

IP9002

Dielectric / Glaze

Description

IP9002 is a Pb, Cd, and Ni free low firing green overglaze that is resistant to various plating solutions. It has a low thermal expansion coefficient allowing for applications which utilize aluminum nitride substrates. It is compatible with various Heraeus conductors designed for aluminum nitride.

Key Features

- Excellent plating solution resistance
- Pinhole free
- Low thermal expansion coefficient (CTE)
- Chemically durable



This picture does not show the packaging of IP9002 and is solely intended for illustration purposes. The products are available in different packaging configurations and may change over time. Please refer to the latest safety data sheets for safety-relevant pictograms.

Typical Properties

Viscosity	60-80 Kcps Brookfield HBTSC4-14 spindle, 6R utility cup at 10 rpm, 25 °C
Solids	76.0 ± 2.0 %
Coverage	170 cm ² /g at 25 um wet film thickness
Metal	None

Recommended Processing Guide

Process Temperature (TDS)	500-600 °C peak temperature. Dwell time of 5-7 minutes.
Film Thickness	8-12 um

Americas

Phone +1 610 825 6050
electronics.americas@heraeus.com

Asia Pacific

Phone +65 6571 7649
electronics.apac@heraeus.com

China

Phone +86 53 5815 9601
electronics.china@heraeus.com

Europe, Middle East and Africa

Phone +49 6181 35 4370
electronics.emea@heraeus.com

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